Kingbright

APTB1612LVBDSYKJ3C

1.6 x 1.25 mm Bi-Color SMD Chip LED Lamp

DESCRIPTIONS

- The Blue source color devices are made with InGaN Light Emitting Diode
- The Super Bright Yellow device is based on light emitting diode chip made from AlGaInP
- · Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- · All devices, equipments and machineries must be electrically grounded

FEATURES

- 1.6 mm x 1.25 mm SMD LED. 0.65 mm thickness
- · Bi-color, low power consumption
- Wide viewing angle
- · Ideal for backlight and indicator
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- RoHS compliant

APPLICATIONS

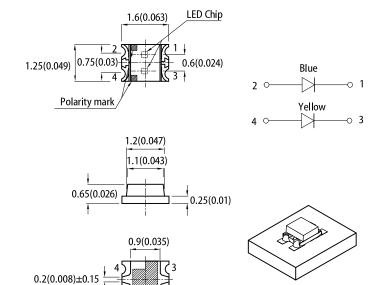
- Backlight
- · Status indicator
- Home and smart appliances
- · Wearable and portable devices
- · Healthcare applications

ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices



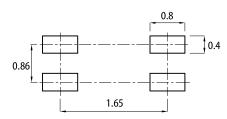
PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN

Polarity mark

(units: mm; tolerance: ± 0.1)



- 1. All dimensions are in millimeters (inches)
- Tolerance is ±0.2(0.008") unless otherwise noted.
 The specifications, characteristics and technical data described in the datasheet are subject to
- change without prior notice.

 The device has a single mounting surface. The device must be mounted according to the specifications

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 2mA [2]		Viewing Angle [1]	
			Min.	Тур.	2θ1/2	
APTB1612LVBDSYKJ3C	■ Blue (InGaN)	Water Clear	10	20	450°	
	Super Bright Yellow (AlGaInP)		20	35	150°	

Notes.
1. 61/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity / luminous flux: +/-15%.

3. Luminous intensity value is traceable to CIE127-2007 standards.





ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value			Unit
			Min.	Тур.	Max.	
Wavelength at Peak Emission I _F = 2mA	λ_{peak}	Blue Super Bright Yellow	-	465 590	-	nm
Dominant Wavelength I _F = 2mA	λ _{dom} ^[1]	Blue Super Bright Yellow	-	470 590	-	nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 2mA	Δλ	Blue Super Bright Yellow	-	22 20	-	nm
Capacitance	С	Blue Super Bright Yellow	-	100 45	-	pF
Forward Voltage I _F = 2mA	V _F ^[2]	Blue Super Bright Yellow	2.2 1.5	2.65 1.85	3.0 2.1	V
Reverse Current (V _R = 5V)	I _R	Blue Super Bright Yellow	-	-	50 10	uA

Notes:

The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd:±1nm.)
 Forward voltage: ±0.1V.
 Wavelength value is traceable to CIE127-2007 standards.
 Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Parameter	Symbol	Va	Unit		
	•	Blue	Super Bright Yellow		
Power Dissipation	P _D	120	75	mW	
Reverse Voltage	V _R	5	5	V	
Junction Temperature	TJ	115	115	°C	
Operating Temperature	T _{op}	-40 T	°C		
Storage Temperature	T _{stg}	-40 T	°C		
DC Forward Current	I _F	30	30	mA	
Peak Forward Current	I _{FM} ^[1]	100	140	mA	
Electrostatic Discharge Threshold (HBM)	-	250	3000	V	

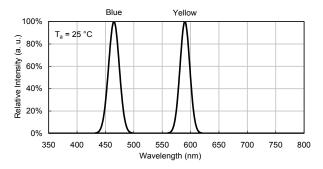
Notes:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.



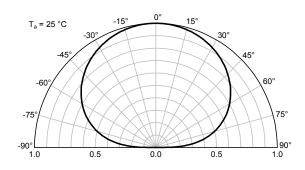


TECHNICAL DATA

RELATIVE INTENSITY vs. WAVELENGTH

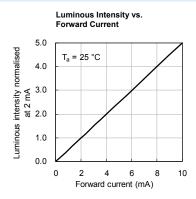


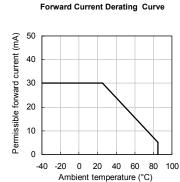
SPATIAL DISTRIBUTION

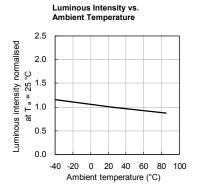


BLUE

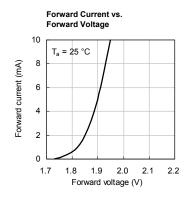
Forward Current vs. Forward Voltage 10 T_a = 25 °C 8 Forward current (mA) 6 4 2 0 2.0 2.2 2.4 2.6 2.8 3.0 Forward voltage (V)

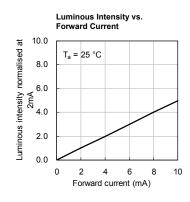


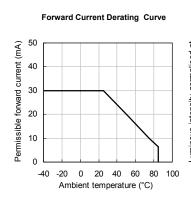


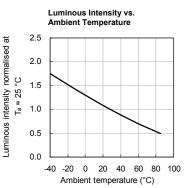


SUPER BRIGHT YELLOW





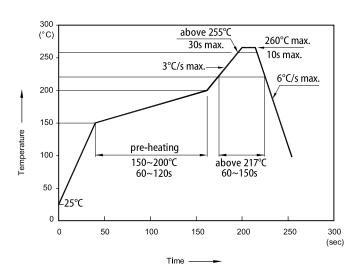






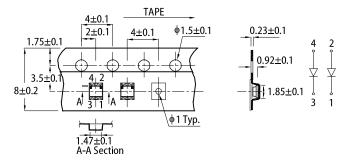
TECHNICAL DATA

REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

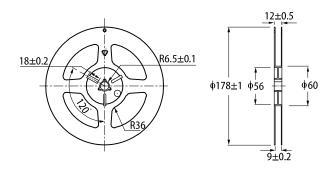


- 1. Don't cause stress to the LEDs while it is exposed to high temperature.
 2. The maximum number of reflow soldering passes is 2 times.
 3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

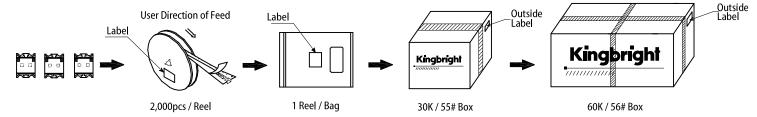
TAPE SPECIFICATIONS (units:mm)

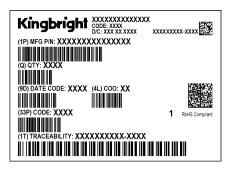


REEL DIMENSION (units: mm)



PACKING & LABEL SPECIFICATIONS





PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.

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